

SPUTTERING TARGET

A. Specifications

Sl. No.	Description	Diameter (inch)	Thickness (mm)	Purity (%)	Qty (Nos)
1	Si-Al (81.5-18.5 at. %)	2	3 (+/- 0.1 mm)	better than 99.99	2
<i>Target with Indium bonded Copper backing plate of 2 mm thick with M2 threaded hole at the center</i>					

Note: The above sputtering target is meant for using with the MAK (MEIVAC) Magnetron and hence the enclosed drawings must be referred and complied for providing the above-mentioned sputtering target.

B. Terms and Conditions

1. Vendor should refer to the drawings enclosed for the sputtering target configuration and its mounting details. Targets to be hot pressed and supplied with Indium bonded copper backing plate, keeper and screw (as per drawing).
2. Vendor should confirm that the offered sputtering target in the quote is compatible with the MAK (MEIVAC) Magnetron, in the quote itself.
3. Supply should be in Full. Part supply not acceptable.
4. Vendor to mention clearly the manufacturer details in the quote. Vendor has to provide valid authorization certificate (if not manufacturer) from OEM.
5. Vendor should provide the certificate of conformance and the purity certificate of the material, from the original manufacturer only and not by the representative / agent.